

0113 279 4449.

IXYS

315 3630

## MegaMOS™ FET

IXTN 15N100

$V_{DS} = 1000 \text{ V}$

$I_{D25} = 15 \text{ A}$

$R_{DS(on)} = 0.6 \Omega$

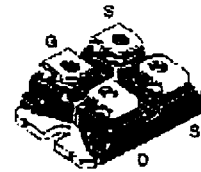
## N-Channel Enhancement Mode



Symbol	Test Conditions	Maximum Ratings	
$V_{DS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	1000	V
$V_{DSM}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{\theta GS} = 10 \text{ k}\Omega$	1000	V
$V_{GS}$	Continuous	$\pm 20$	V
$V_{GSM}$	Transient	$\pm 30$	V
$I_{D25}$	$T_C = 25^\circ\text{C}$	15	A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	60	A
$P_D$	$T_C = 25^\circ\text{C}$	400	W
$T_J$		-40 ... +150	$^\circ\text{C}$
$T_{JM}$		150	$^\circ\text{C}$
$T_{stg}$		-40 ... +150	$^\circ\text{C}$
$V_{Tsol}$	50/60 Hz $t = 1 \text{ min}$ $I_{sol} \leq 1 \text{ mA}$ $t = 1 \text{ s}$	2500 3000	V- V-
$M_d$	Mounting torque Terminal connection torque (M4)	1.5/13 1.5/13	Nm/lb.in. Nm/lb.in.
Weight		30	g

miniBLOC, SOT-227 B

E153432



G = Gate D = Drain

S = Source

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

## Features

- International standard package miniBLOC (ISOTOP compatible)
- Isolation voltage 3000 V-
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Low drain-to-case capacitance (< 50 pF)
- Low package inductance (< 10 nH)
- easy to drive and to protect

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$V_{DS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 6 \text{ mA}$	1000		V
$V_{DS(Th)}$	$V_{DS} = V_{GS}$ , $I_D = 20 \text{ mA}$	2		5 V
$I_{DSS}$	$V_{GS} = \pm 20 \text{ V}_{DC}$ , $V_{DS} = 0$			$\pm 500 \text{ nA}$
$I_{DSS}$	$V_{DS} = 0.8 \cdot V_{DSS}$ , $T_J = 25^\circ\text{C}$ $V_{GS} = 0 \text{ V}$ , $T_J = 125^\circ\text{C}$			400 $\mu\text{A}$ 2 mA
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \cdot I_{DSS}$ Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2\%$			0.6 $\Omega$

## Applications

- AC motor speed control
- DC servo and robot drives
- Uninterruptible power systems (UPS)
- Switch-mode and resonant-mode power supplies
- DC choppers

## Advantages

- Easy to mount with 2 screws
- Space savings
- High power density

IXYS reserves the right to change limits, test conditions, and dimensions.

751

© 1999 IXYS All rights reserved

1 - 4

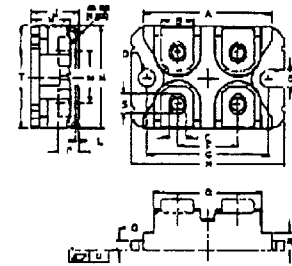


**IXTN 15N100**

Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$g_{fs}$	$V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ pulsed	10	28	S
$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		8000	pF
$C_{oss}$			600	pF
$C_{rss}$			150	pF
$t_{d(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DS25}, I_D = 0.5 I_{D25}$ $R_G = 1\ \Omega$ , (External)			100 ns
$t_r$				110 ns
$t_{d(off)}$				220 ns
$t_f$				105 ns
$Q_{g(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DS25}, I_D = 0.5 I_{D25}$		180	280 nC
$Q_{gs}$			45	65 nC
$Q_{gd}$			80	150 nC
$R_{th(j-c)}$			0.31	K/W
$R_{th(c-k)}$			0.05	K/W

Symbol	Test Conditions	Characteristic Values ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$I_S$	$V_{DS} = 0\text{ V}$			15 A
$I_{DM}$	Repetitive; pulse width limited by $T_{JM}$			60 A
$V_{SD}$	$I_C = I_S, V_{GS} = 0\text{ V}$ , Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$			1.5 V
$t_{tr}$	$I_C = I_S, \frac{dI_C}{dt} = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$	1000		ns

**miniBLOC, SOT-227 B**



M4 screws (4x) supplied

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.5	31.7	1.241	1.249
B	7.8	8.2	0.307	0.323
C	4.0	-	0.158	-
D	4.1	4.3	0.162	0.169
E	4.1	4.3	0.162	0.169
F	14.8	15.1	0.587	0.595
G	30.1	30.3	1.186	1.193
H	38.0	38.2	1.497	1.505
J	11.8	12.2	0.465	0.481
K	6.9	9.7	0.351	0.382
L	0.75	0.85	0.030	0.033
M	12.6	12.8	0.496	0.504
N	25.2	25.4	0.993	1.001
O	1.95	2.05	0.077	0.081
P	-	5.0	-	0.197

IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETS and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,881,108 5,017,508 5,048,861 5,187,117 5,486,718  
4,850,072 4,931,044 5,034,798 5,063,307 5,237,481 5,361,025



IXTN 15N100

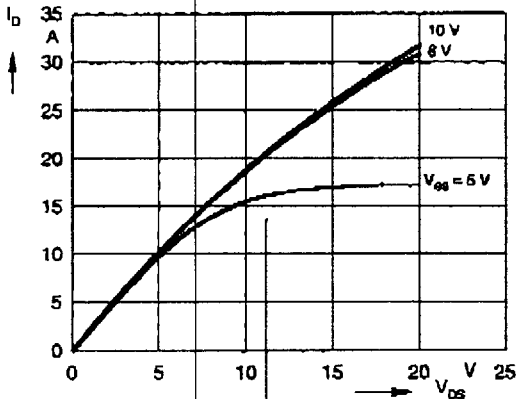


Fig. 1 Typical output characteristics  $I_D = f(V_{DS})$

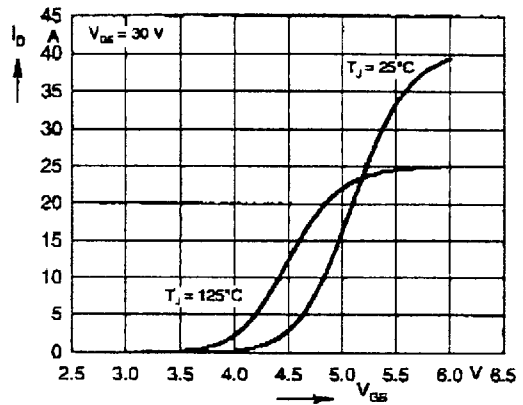


Fig. 2 Typical transfer characteristics  $I_D = f(V_{GS})$

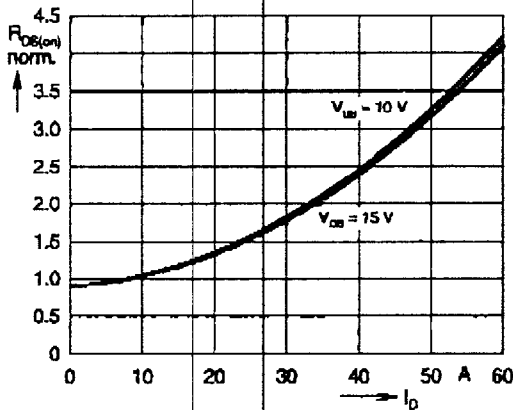


Fig. 3 Typical normalized  $R_{DS(on)} = f(I_D)$

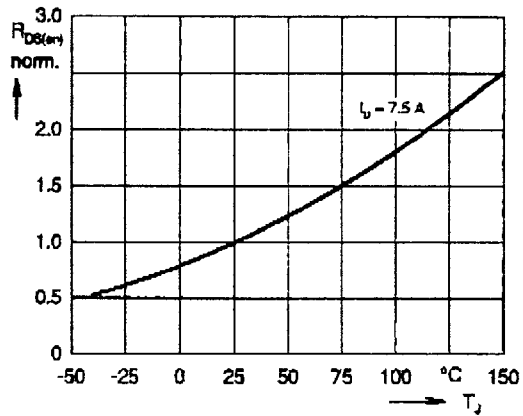


Fig. 4 Typical normalized  $R_{DS(on)} = f(T_J)$

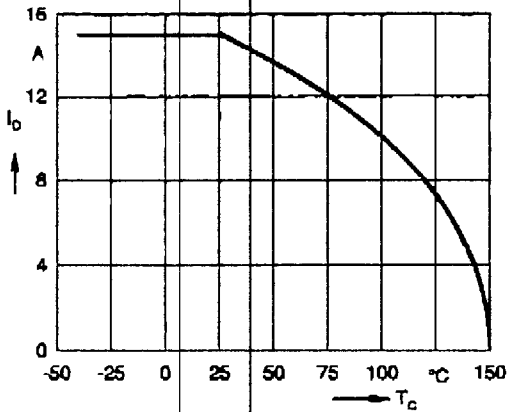


Fig. 5 Continuous drain current  $I_D = f(T_C)$

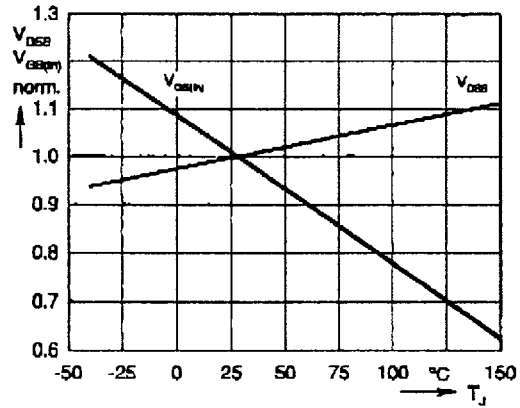


Fig. 6 Typical normalized  $V_{DS(on)} = f(T_J)$ ,  $V_{GS(on)} = f(T_J)$

IXYS reserves the right to change limits, test conditions, and dimensions.

© 1999 IXYS All rights reserved



IXTN 15N100

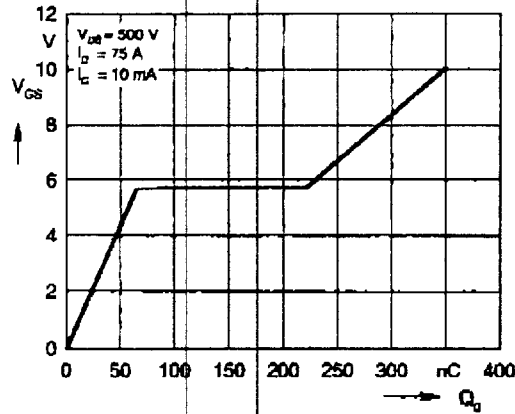


Fig. 7 Typical turn-on gate charge characteristics

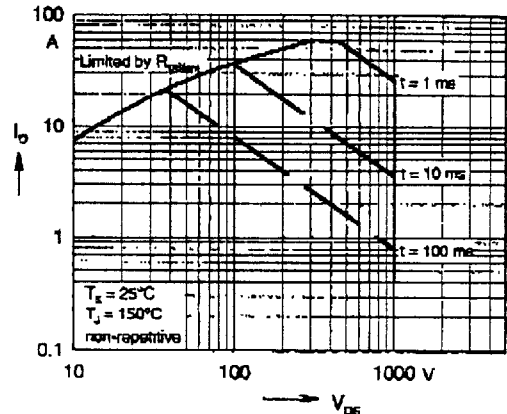


Fig. 8 Forward Safe Operating Area,  $I_D = f(V_{DS})$

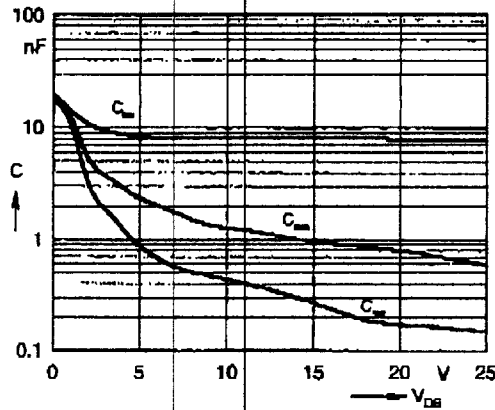


Fig. 9 Typical capacitances  $C = f(V_{DS})$ ,  $f = 1 \text{ MHz}$

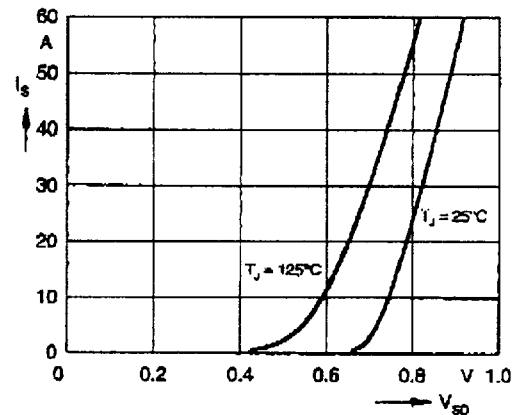


Fig. 10 Typical forward characteristics of reverse diode,  $I_S = f(V_{SD})$

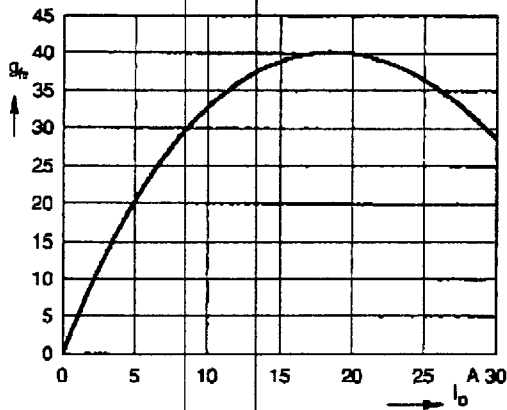


Fig. 11 Typical transconductance  $g_m = f(I_D)$

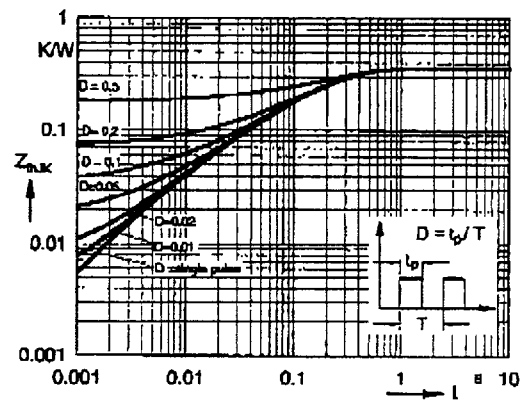


Fig. 12 Transient thermal resistance  $Z_{\theta(j-c)} = f(t)$

IXYS reserves the right to change limits, test conditions, and dimensions.

© 1999 IXYS All rights reserved